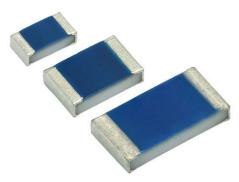


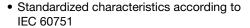


Platinum SMD Flat Chip Temperature Sensor



PTS AT SMD flat chip temperature sensors are the perfect choice for temperature control of electronics operating under varying environmental conditions. The highly controlled platinum thin film manufacturing process guarantees an outstanding stability of temperature characteristics which ensures reliable operation even under harsh conditions. Typical applications include automotive, aviation and industrial electronics.

FEATURES





- AEC-Q200 qualified
- Short reaction times down to $t_{0.9} \le 3$ s (in air)
- Outstanding stability of temperature characteristic
- ROHS COMPLIANT HALOGEN FREE
- Superior temperature cycling robustness
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

Temperature measurement and control in

- · Automotive electronics
- Aviation electronics
- · Industrial electronics

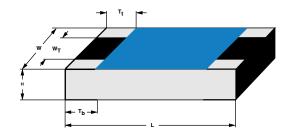
TECHNICAL SPECIFICAT	IONS						
DESCRIPTION		PTS0603M	PTS0805M	PTS1206M			
Resistance values R ₀ at 0 °C		100 Ω 100 Ω, 500 Ω 100 Ω, 500 Ω, 10					
Temperature coefficient (0 °C to +100 °C)		+3850 ppm/K					
Tolerance classes		F0.3, F0.6					
Temperature range			-55 °C to +175 °C				
Long term stability $ \Delta R_0/R_0 $; R_0 change after 1000 h at +155 °C		≤ 0.1 %					
Insulation resistance		> 10 MΩ					
	100 Ω	0.1 mA to 0.50 mA	0.1 mA to 1.0 mA	0.1 mA to 1.0 mA			
Measurement current I $_{meas.}$ (DC) $^{(1)}$	500 Ω	-	0.1 mA to 0.40 mA	0.1 mA to 0.40 mA			
	1000 Ω	-	-	0.1 mA to 0.25 mA			
Self-heating at 0 °C $^{(2)}$ Calm air $(\nu = 0.0 \text{ m/s})$		≤ 0.9 K/mW ≤ 0.8 K/mW ≤ 0		≤ 0.7 K/mW			
	Flowing water	t _{0.5} ≤ 0.1 s	$t_{0.5} \le 0.2 \text{ s}$	$t_{0.5} \le 0.3 \text{ s}$			
Thermal response time (2)	(v = 0.4 m/s)	<i>t</i> _{0.9} ≤ 0.2 s	$t_{0.9} \le 0.3 \text{ s}$	$t_{0.9} \le 0.4 \text{ s}$			
	Flowing air	$t_{0.5} \le 1.0 \text{ s}$	$t_{0.5} \le 1.5 \text{ s}$	$t_{0.5} \le 2.0 \text{ s}$			
	(v = 3.0 m/s)	<i>t</i> _{0.9} ≤ 2.0 s	$t_{0.9} \le 2.0 \text{ s}$ $t_{0.9} \le 3.0 \text{ s}$ t_0				

Notes

- (1) Indicated measurement currents can be applied continuously with self-heating effect of less then 0.1 °C.
- (2) Valid for sensor element only.

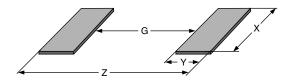


DIMENSIONS in millimeters



DIMENSIONS AND MASS							
TYPE	н	L	w	W _T	T _t	T _b	MASS (mg)
PTS 0603	0.45 + 0.1/- 0.05	1.55 +0.05 / -0.1	0.85 ± 0.1	> 75 % of W	0.3 + 0.15/- 0.2	0.3 + 0.15/- 0.2	1.9
PTS 0805	0.45 + 0.1 / - 0.05	2.0 ± 0.1	1.25 ± 0.15	> 75 % of W	0.4 ± 0.2	0.4 ± 0.2	4.6
PTS 1206	0.55 ± 0.1	3.1 + 0.1 / - 0.2	1.6 ± 0.15	> 75 % of W	0.5 ± 0.25	0.5 ± 0.25	9.2

SOLDER PAD DIMENSIONS in millimeters



RECOMMENDED SOLDERPAD DIMENSIONS								
TYPE	WAVE SOLDERING				REFLOW SOLDERING			
ITPE	G	Y	Х	Z	G	Y	Х	Z
PTS 0603	0.55	1.1	1.1	2.75	0.65	0.7	0.95	2.05
PTS 0805	0.8	1.25	1.50	3.2	0.9	0.9	1.4	2.7
PTS 1206	1.4	1.5	1.9	4.4	1.5	1.15	1.75	3.8

DESCRIPTION

A homogeneous film of platinum is deposited on a high grade (Al_2O_3) ceramic substrate and conditioned to achieve the correct temperature coefficient and stability. The sensor-elements are covered by a protective coating designed for electrical, mechanical and climatic protection. The terminations receive a final pure matte tin on nickel plating, the immunity against tin whisker growth has been proven under extensive testing.

QUALITY

The result of the determined production is verified by an extensive testing procedure and optical inspection performed on 100 % of the individual sensors. Only accepted products are laid directly into the paper tape in accordance with IEC 60286-3.

STORAGE

Solderability is specified for 2 years after production or re-qualification. The permitted storage time is 20 years.

ASSEMBLY

The Pt-sensors are suitable for processing on automatic SMD assembly systems. They are suitable for automatic soldering using wave, reflow or vapour phase as shown in IEC61760-1. The encapsulation is resistant to all cleaning solvents commonly used in the electronics industry,

including alcohols, esters and aqueous solutions. The suitability of conformal coatings, if applied, shall be qualified by appropriate means to ensure the long-term stability of the whole system. The use of potting resins in close contact with the protective coating or terminations is not recommended.

For frequent high temperature usage, thermal compatible substrates and solder alloys should be selected to minimize any thermal mismatch.

All products comply with the CEFIC-EECA-EICTA list of legal restrictions on hazardous substances.

This includes full compatibility with the following directives:

- 2000/53/EC End of Life Vehicle Directive (ELV) and Annex II (ELV II)
- 2011/65/EU Restriction of the use of Hazardous Substances Directive (RoHS)
- 2002/96/EC Waste Electrical and Electronic Equipment Directive (WEEE)

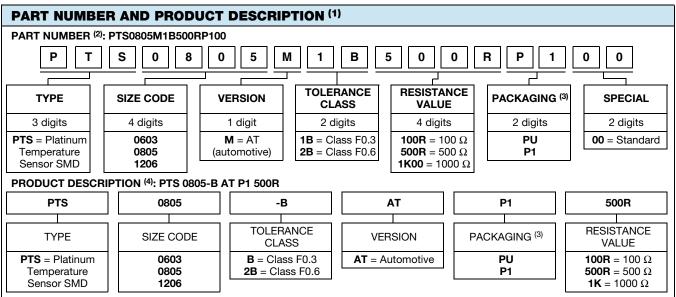
APPROVALS

The Pt-sensors are tested in accordance with

- IEC 60751
- IEC 60068 series

The Pt-sensors are qualified according to AEC-Q200.





Notes

- (1) Products can be ordered using either the PART NUMBER or the PRODUCT DESCRIPTION.
- (2) The part number is shown to facilitate the introduction of a unified part numbering system.
- (3) Please refer to table PACKAGING.
- (4) We recommend that the Production Description is used to minimize the possibility of errors in order handling.

PACKAGING								
TYPE	CODE	QUANTITY	CARRIER TAPE	WIDTH	PITCH	BOX/REEL	BOX/REEL DIAMETER	
PTS 0603	PU	100	Paper tape acc.	Paper tape acc.	0	4	Box	114 mm
PTS 0805 PTS 1206	P1	1000	IÉC 60286-3	8 mm	4 mm	Reel	180 mm/7"	

TESTS AND REQUIREMENTS					
TEST	CONDITIONS	REQUIREMENTS $ \Delta R_0/R_0 \le$			
High temperature exposure (storage)	AEC-Q200, 1000 h at 155 °C	0.1 %			
High temperature exposure (storage)	1000 h at 175 °C	0.2 %			
Temperature cycling	AEC-Q200, 1000 cycles -55 °C to +155 °C	0.5 %			
Biased humidity	1000 h, 1 mA biased at 85 °C / 85 % RH	0.5 %			
Operational life	1000 h, 1 mA biased at 125 °C	0.2 %			
Vibration	MIL-STD 202, method 204	0.1 %			
Mechanical shock	MIL-STD 202, method 213	0.1 %			
Resistance to soldering heat	Solder bath dipping 10 s at 260°C	0.25 %			
ESD	AEC-Q200, HBM (CD) 1.0 kV (0603), 1.5 kV (0805), 2.0 kV (1206)	0.5 %			
Board flex	AEC-Q200-005, 2 mm during 60 s	0.2 %			
Terminal strength	AEC-Q200-006, shear test 10 N / 17.7 N during 60 s	0.25 %			

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FUNCTIONAL PERFORMANCE

The temperature resistance relationships of the PTS series follow different equations:

For the temperature range of -55 °C up to 0 °C:

$$R_T = R_0 \times (1 + A \times T + B \times T^2 + C \times (T - 100 \,^{\circ}\text{C}) \times T^3)$$

And for the temperature range of 0 °C up to +175 °C:

$$R_{T} = R_{0} \times (1 + A \times T + B \times T^{2})$$

R_T: Resistance as a function of temperature

R₀: Nominal resistance value at 0 °C

T: Temperature in °C

According to IEC 60751 the values of the coefficients are:

 $A = 3.9083 \times 10^{-3} \, ^{\circ}\text{C}^{-1}$

 $B = -5.775 \times 10^{-7} \, {}^{\circ}C^{-2}$

 $C = -4.183 \times 10^{-12} \, {}^{\circ}C^{-4}$

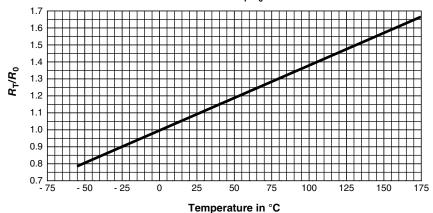
The tolerances values of the PTS series are classified by the following equations as specified by IEC 60751:

Class F0.3: $\Delta T_{\text{F0.3}} = \pm (0.3 + 0.005 \times |T|)$

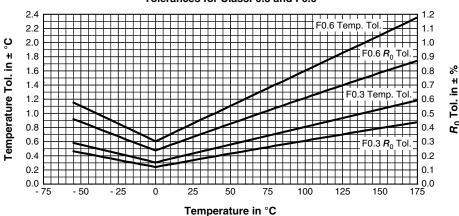
Class F0.6: $\Delta T_{\text{F0.6}} = \pm (0.6 + 0.010 \times |T|)$

TEMPERATURE	NO	MINAL RESISTANCE	TOLERANCE in K		
in °C	$R_0 = 100 \Omega$	$R_0 = 500 \Omega$	$R_0 = 1000 \Omega$	CLASS F0.3	CLASS F0.6
-55	78.319	391.59	783.19	± 0.58	± 1.15
-50	80.306	401.53	803.06	± 0.55	± 1.10
-25	90.192	450.96	901.92	± 0.43	± 0.85
0	100.00	500.00	1000.00	± 0.30	± 0.60
25	109.73	548.67	1097.35	± 0.43	± 0.85
50	119.40	596.99	1193.97	± 0.55	± 1.10
75	128.99	644.94	1289.87	± 0.68	± 1.35
100	138.51	692.53	1385.06	± 0.80	± 1.60
125	147.95	739.76	1479.51	± 0.93	± 1.85
150	157.33	786.63	1573.25	± 1.05	± 2.10
175	166.63	833.13	1666.27	± 1.18	± 2.35

Ratio R_T/R₀



Tolerances for ClassF0.3 and F0.6





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